



Material Content Data Sheet



Halogen-Free

Sales Product Name	AIDK08S65C5	Issued	12. May 2021
MA#	MA001728876		
Package	PG-TO263-2-1	Weight*	1466.46 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	siliconcarbide	409-21-2	0.667	0.05	0.05	455	455
leadframe	inorganic material	phosphorus	7723-14-0	0.225	0.02		154	
	non noble metal	iron	7439-89-6	0.751	0.05		512	
	non noble metal	copper	7440-50-8	749.949	51.14	51.21	511399	512065
wire	non noble metal	aluminium	7429-90-5	0.800	0.05	0.05	545	545
encapsulation	inorganic material	zincoxide	1314-13-2	5.573	0.38		3800	
	miscellaneous	miscellaneous	-	22.291	1.52		15200	
	plastics	epoxy resin	-	83.591	5.70		57002	
	inorganic material	silicondioxide	60676-86-0	445.818	30.40	38.00	304009	380011
leadfinish	non noble metal	tin	7440-31-5	11.700	0.80	0.80	7978	7978
plating	inorganic material	phosphorus	7723-14-0	0.007			5	
	non noble metal	nickel	7440-02-0	2.778	0.19	0.19	1894	1899
solder	non noble metal	tin	7440-31-5	0.013			9	
	noble metal	silver	7440-22-4	0.016			11	
	non noble metal	lead	7439-92-1	0.604	0.04	0.04	412	432
heatspreader	inorganic material	phosphorus	7723-14-0	0.043			29	
	non noble metal	iron	7439-89-6	0.142	0.01		97	
	non noble metal	copper	7440-50-8	141.498	9.65	9.66	96489	96615
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com